Infrared Hot Air RGA Rowerk Station With 55kg Weight And 0.3-5mm

Infrared Hot Air BGA Rework Station With 55kg Weight And 0.3-5mm PCB

Basic Information

Place of Origin: CHINA
Brand Name: WDS
Certification: CE
Model Number: WDS620

 Minimum Order Quantity:

• Payment Terms:

Packaging Details: wooden caseDelivery Time: 3-5days

TT

• Supply Ability: 200



Product Specification

• Placement Accuracy: ±0.01mm

Bga Size: Max. 80x80mm
 Heating Method: Infrared + Hot Air
 Dimensions: L800xW780xH810mm

• Power Consumption: 5200W

Weight: Approx. 55kgPcb Size: Max. 470x380mm

• Pcb Thickness: 0.3-5mm

Highlight: Infrared Hot Air BGA Rework Station,

5mm PCB BGA Rework Station, Infrared Hot Air BGA Rework System



Product Description:

One of the standout features of this rework station is the infrared preheating table, which is made up of three heating zones. This ensures even and consistent heating across the entire area of the PCB, helping to prevent damage to delicate components. The preheating table can be adjusted to a temperature range of 20-300°C, allowing for precise control over the reflow process.

The Semi Automatic BGA Rework Station is easy to operate, with a user-friendly interface that allows for quick and efficient setup and adjustment. The machine is equipped with a high-resolution CCD camera that provides clear and accurate images of the rework area, making it easy to monitor the process and ensure that everything is working correctly.

This rework station is powered by a 220V/110V power supply, making it suitable for use in a variety of settings. It is built to last, with a robust and durable design that can withstand the demands of frequent use. The Semi Automatic BGA Rework Station is a valuable tool for anyone involved in electronics repair or manufacturing, providing a high level of precision and control over the rework process.

Features:

Product Name: Semi Automatic BGA Rework Station

BGA Size: Max. 80x80mm

Dimensions: L800xW780xH810mm Heating Method: Infrared + Hot Air Placement Accuracy: ±0.01mm

Weight: Approx. 55kg Optical Alignment System BGA Rework Station

Applications:

The WDS620 BGA rework station is equipped with three heating zones, which allow for precise and accurate rework. The rework station has a maximum BGA size of 80x80mm, and is designed to work with PCBs that are 0.3-5mm thick. The semi-automatic placement mode allows for easy and fast rework, making it perfect for high-volume production lines.

This BGA rework station is suitable for many scenarios, including repairing laptop motherboards, game consoles, mobile phones, and other electronic devices. The WDS620 BGA rework station is capable of repairing various BGA chips, including PBGA, CBGA, CCGA, and other BGA chips.

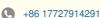
The WDS620 BGA rework station is packaged in a wooden case, ensuring it arrives safely. The minimum order quantity for this product is one, and delivery time is between 3-5 days. Payment terms are TT, and the supply ability is 200. This BGA rework station is designed for use with a 220V/110V power supply and has a power consumption of 5200W.

FAQ:

- Q: What is the brand name of this BGA rework station?
- A: The brand name is WDS.
- Q: What is the model number of this BGA rework station?
- A: The model number is WDS620.
- Q: Where is the place of origin of this BGA rework station?
- A: The place of origin is China.
- Q: Is this BGA rework station certified?
- A: Yes, it is certified with CE.
- Q: What are the packaging details, delivery time, payment terms, and supply ability of this BGA rework station?
- A: The packaging details are wooden case, the delivery time is 3-5 days, the payment terms are TT, and the supply ability is 200.



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